

United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER OF PATENTS AND TRADEMARKS Washington, D.C. 20231 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
. 09/600,931	07/21/2000	KOJI YAMAMOTO	362-43PCT/U	2670
23869	7590 09/19/2002			
HOFFMANN & BARON, LLP			EXAMINER	
	6900 JERICHO TURNPIKE SYOSSET, NY 11791		LEE, EUGENE	
			ART UNIT	PAPER NUMBER
			2815	
		•	DATE MAILED: 09/19/2002	

Please find below and/or attached an Office communication concerning this application or proceeding.

		4m
	Application No.	Applicant(s)
Office Assistan Communication	09/600,931	YAMAMOTO ET AL.
Office Action Summary	Examiner	Art Unit
	Eugene Lee	2815
The MAILING DATE of this communication app Period for Reply	pears on the cover sheet	with the correspondence address
A SHORTENED STATUTORY PERIOD FOR REPL' THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply - If NO period for reply is specified above, the maximum statutory period of - Failure to reply within the set or extended period for reply will, by statute - Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b). Status	36(a). In no event, however, may y within the statutory minimum of will apply and will expire SIX (6) No., cause the application to become	y a reply be timely filed thirty (30) days will be considered timely. MONTHS from the mailing date of this communication. ABANDONED (35 U.S.C. § 133).
1) Responsive to communication(s) filed on 17.	June 2002 .	
2a) ☐ This action is FINAL . 2b) ☑ Th	is action is non-final.	
3) Since this application is in condition for allowationsed in accordance with the practice under Disposition of Claims		
4)⊠ Claim(s) <u>1-6,8-13,15 and 16</u> is/are pending in	the application.	
4a) Of the above claim(s) is/are withdraw	wn from consideration.	
5) Claim(s) is/are allowed.		
6) Claim(s) <u>1-6,8-13,15 and 16</u> is/are rejected.		
7) Claim(s) is/are objected to.		
8) Claim(s) are subject to restriction and/o	r election requirement.	
Application Papers		
9) The specification is objected to by the Examine	r.	
10)☐ The drawing(s) filed on is/are: a)☐ accept	oted or b) objected to b	y the Examiner.
Applicant may not request that any objection to the	- · ·	
11) The proposed drawing correction filed on		disapproved by the Examiner.
If approved, corrected drawings are required in rep	•	
12) The oath or declaration is objected to by the Ex-	aminer.	
Priority under 35 U.S.C. §§ 119 and 120		
13) Acknowledgment is made of a claim for foreign	n priority under 35 U.S.C). § 119(a)-(d) or (f).
a)⊠ All b)☐ Some * c)☐ None of:		
1. Certified copies of the priority documents		
2. Certified copies of the priority documents		· · ·
 3. Copies of the certified copies of the prior application from the International But * See the attached detailed Office action for a list 	reau (PCT Rule 17.2(a)).
14) Acknowledgment is made of a claim for domestic	-	
a) The translation of the foreign language pro	visional application has	been received.
Attachment(s)	•	
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449) Paper No(s)	5) Notice	ew Summary (PTO-413) Paper No(s) of Informal Patent Application (PTO-152)

Application/Control Number: 09/600,931

Art Unit: 2815

DETAILED ACTION

Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 1 thru 6, 8 thru 13, 15 and 16 are rejected under 35 U.S.C. 103(a) as being unpatentable over Jain '423 in view of Shiue et al. '088. Jain discloses (see, for example, FIG. 13) a damascene interconnection comprising a conductor-filled trench (interconnection trench) 64 and insulating pillars (protrusions) 50. FIG. 10 shows a plan view of a pillared landing pad (pad trench) 55 where multiple protrusions are dispersed throughout.

FIG. 6 shows the damascene interconnection formed by a patterned insulating layer 22 over a substrate 20. Conducting segments (conductive film) 32, 44 and 46 lie between insulating pillars 38. In column 5, lines 34-45, Jain states that the incorporation of insulating pillars divides a wider conductor and, hence, minimizes dishing.

Jain does not disclose a contact hole formed within said pad trench to electrically connect said conductive film to a further conductive film formed below said insulating film, wherein said contact hole and said further conductive film substantially suppress an increase in electrical resistance in said pad trench due to formation of said protrusion. However, Shiue shows (see, for example, FIG. 3) a bond pad structure comprising a third metal pad 30, second via plugs (contact hole) 36, and a second metal pad (further conductive film) 32. The third metal pad is connected to the second metal pad through the second via plugs. In the abstract, Shiue teaches that reliable

Application/Control Number: 09/600,931

Art Unit: 2815

interconnections are provided between the bond pad structure and the next level of integration.

Therefore, it would have been obvious to one of ordinary skill in the art at the time of invention to include these second via plugs and second metal pad in Jain's invention in order to connect the conducting segments of Jain's invention to a further integration within the substrate.

Regarding the limitation "substantially suppress an increase in electrical resistance in said pad trench due to formation of said protrusion", it has been held that a recitation with respect to the manner in which a claimed apparatus is intended to be employed does not differentiate the claimed apparatus from a prior art apparatus satisfying the claimed structural limitations.

Regarding claims 4 and 11, see FIG. 3 and element 38. Also, in column 6, lines 45-53, Jain states that many other insulating patterns may be construed that produce the same effect (i.e. reducing dishing by the narrowing of wide trenches).

Response to Arguments

3. Applicant's arguments filed 6/17/02 have been fully considered but they are not persuasive. The new limitation "at a position near said protrusion" does not differentiate the applicant's invention from Jain in view of Shiue. In FIG. 6 of Jain, when a contact hole is formed underneath conducting segments 32, 44, 46, the contact hole will form near the insulating pillars (protrusions) 38. Therefore, the Examiner does not see how the new limitation differentiates the claimed invention from Jain in view of Shiue.

The Shiue reference is only being used to show that interconnections can be made from a metal pad to a lower metal pad. Therefore, the metal pad 30 in Shiue is analogous to the conducting segments 32, 44, 46 of Jain which is also a metal pad. The Shiue reference is

Application/Control Number: 09/600,931

Art Unit: 2815

simply showing that a metal pad may be connected to a lower metal layer (by way of contact

holes) in order to accommodate further integration. The idea that the metal pad of Shiue should

Page 4

also be formed of conducting segments (instead of one whole metal layer) and have protrusions

is irrelevant since the applicability of Shuie reference is based on whether a metal pad can be

connected to a lower metal pad by contact holes, which Shiue clearly shows.

INFORMATION ON HOW TO CONTACT THE USPTO

Any inquiry concerning this communication or earlier communications from the

examiner should be directed to Eugene Lee whose telephone number is 703-305-5695. The

examiner can normally be reached on M-F 8-5.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's

supervisor, Eddie C. Lee can be reached on 703-308-1690. The fax phone numbers for the

organization where this application or proceeding is assigned are 703-308-7722 for regular

communications and 703-308-7722 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding

should be directed to the receptionist whose telephone number is 703-308-0956.

Eugene Lee

September 9, 2002

EDDIE LE

SUPERVISORY PATENT EXAMINER

TECHNOLOGY CENTER 2800